

## 3.3-V ABT 16-Bit Buffers/Drivers With 3-State Outputs

Check for Samples: [SN54LVTH16244A](#), [SN74LVTH16244A](#)

### FEATURES

- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation**
- **Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )**
- **Support Unregulated Battery Operation Down to 2.7 V**
- **Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$**
- **$I_{off}$  and Power-Up 3-State Support Hot Insertion**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**
- **Latch-Up Performance Exceeds 500 mA Per JESD 17**
- **ESD Protection Exceeds JESD 22**
  - **2000-V Human-Body Model (A114-A)**
  - **200-V Machine Model (A115-A)**

### DESCRIPTION

The LVTH16244A devices are 16-bit buffers and line drivers designed for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

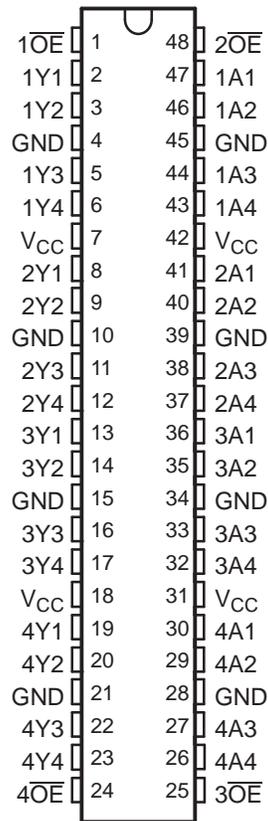
These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.



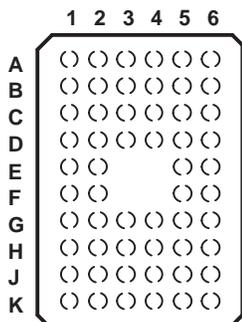
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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SN54LVTH16244A . . . WD PACKAGE  
 SN74LVTH16244A . . . DGG, DGV, OR DL PACKAGE  
 (TOP VIEW)



**GQL OR ZQL PACKAGE  
(TOP VIEW)**

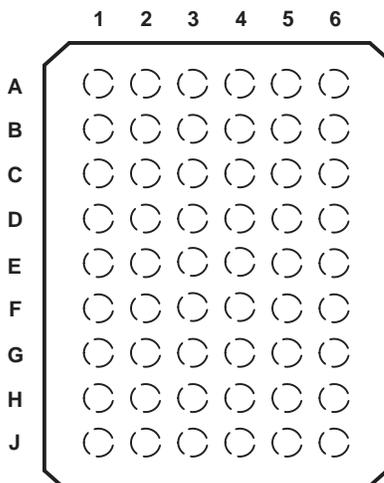


**TERMINAL ASSIGNMENTS<sup>(1)</sup>  
(56-Ball GQL/ZQL Package)**

|          | 1                | 2   | 3               | 4               | 5   | 6                |
|----------|------------------|-----|-----------------|-----------------|-----|------------------|
| <b>A</b> | $1\overline{OE}$ | NC  | NC              | NC              | NC  | $2\overline{OE}$ |
| <b>B</b> | 1Y2              | 1Y1 | GND             | GND             | 1A1 | 1A2              |
| <b>C</b> | 1Y4              | 1Y3 | V <sub>CC</sub> | V <sub>CC</sub> | 1A3 | 1A4              |
| <b>D</b> | 2Y2              | 2Y1 | GND             | GND             | 2A1 | 2A2              |
| <b>E</b> | 2Y4              | 2Y3 |                 |                 | 2A3 | 2A4              |
| <b>F</b> | 3Y1              | 3Y2 |                 |                 | 3A2 | 3A1              |
| <b>G</b> | 3Y3              | 3Y4 | GND             | GND             | 3A4 | 3A3              |
| <b>H</b> | 4Y1              | 4Y2 | V <sub>CC</sub> | V <sub>CC</sub> | 4A2 | 4A1              |
| <b>J</b> | 4Y3              | 4Y4 | GND             | GND             | 4A4 | 4A3              |
| <b>K</b> | $4\overline{OE}$ | NC  | NC              | NC              | NC  | $3\overline{OE}$ |

(1) NC – No internal connection

**GRD OR ZRD PACKAGE  
(TOP VIEW)**



**TERMINAL ASSIGNMENTS<sup>(1)</sup>  
(54-Ball GRD/ZRD Package)**

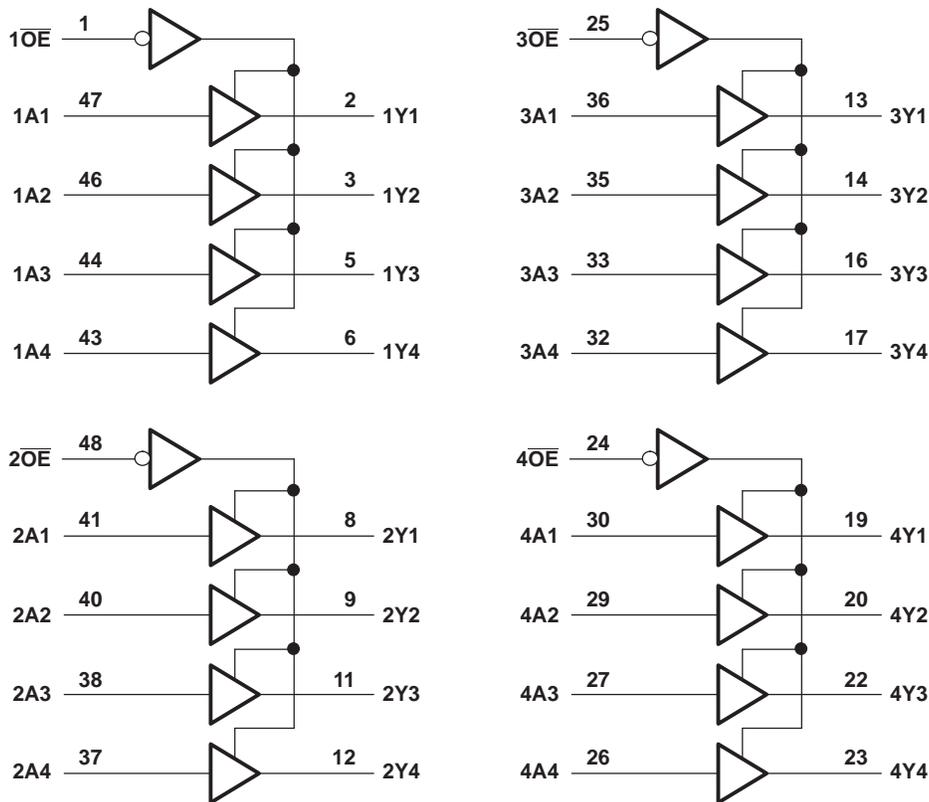
|          | 1   | 2   | 3                | 4                | 5   | 6   |
|----------|-----|-----|------------------|------------------|-----|-----|
| <b>A</b> | 1Y1 | NC  | $1\overline{OE}$ | $2\overline{OE}$ | NC  | 1A1 |
| <b>B</b> | 1Y3 | 1Y2 | NC               | NC               | 1A2 | 1A3 |
| <b>C</b> | 2Y1 | 1Y4 | V <sub>CC</sub>  | V <sub>CC</sub>  | 1A4 | 2A1 |
| <b>D</b> | 2Y3 | 2Y2 | GND              | GND              | 2A2 | 2A3 |
| <b>E</b> | 3Y1 | 2Y4 | GND              | GND              | 2A4 | 3A1 |
| <b>F</b> | 3Y3 | 3Y2 | GND              | GND              | 3A2 | 3A3 |
| <b>G</b> | 4Y1 | 3Y4 | V <sub>CC</sub>  | V <sub>CC</sub>  | 3A4 | 4A1 |
| <b>H</b> | 4Y3 | 4Y2 | NC               | NC               | 4A2 | 4A3 |
| <b>J</b> | 4Y4 | NC  | $4\overline{OE}$ | $3\overline{OE}$ | NC  | 4A4 |

(1) NC – No internal connection

**FUNCTION TABLE  
(EACH 4-BIT BUFFER)**

| INPUTS          |   | OUTPUT<br>Y |
|-----------------|---|-------------|
| $\overline{OE}$ | A |             |
| L               | H | H           |
| L               | L | L           |
| H               | X | Z           |

**LOGIC DIAGRAM (POSITIVE LOGIC)**



Pin numbers shown are for the DGG, DGV, DL, and WD packages.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|                  |   | MIN                | MAX                   | UNIT |
|------------------|---|--------------------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range  | -0.5               | 4.6                   | V    |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>  | -0.5               | 7                     | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5               | 7                     | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high state <sup>(2)</sup>                        | -0.5               | V <sub>CC</sub> + 0.5 |      |
| I <sub>O</sub>   | Current into any output in the low state  | SN54LVTH16244A     | 96                    | V    |
|                  |   | SN74LVTH16244A     | 128                   |      |
| I <sub>O</sub>   | Current into any output in the high state <sup>(3)</sup>                                    | SN54LVTH16244A     | 48                    | V    |
|                  |   | SN74LVTH16244A     | 64                    |      |
| I <sub>IK</sub>  | Input clamp current   | V <sub>I</sub> < 0 | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> < 0 | -50                   | mA   |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(4)</sup>  | DGG package        | 70                    | °C/W |
|                  |   | DGV package        | 58                    |      |
|                  |   | DL package         | 63                    |      |
|                  |   | GQL/ZQL package    | 42                    |      |
|                  |   | GRD/ZRD package    | 36                    |      |
| T <sub>stg</sub> | Storage temperature range   | -65                | 150                   | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (3) The current flows only when the output is in the high state and V<sub>O</sub> > V<sub>CC</sub>.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

**RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

|                     |                                    | SN54LVTH16244A  |     | SN74LVTH16244A |     | UNIT |
|---------------------|------------------------------------|-----------------|-----|----------------|-----|------|
|                     |                                    | MIN             | MAX | MIN            | MAX |      |
| V <sub>CC</sub>     | Supply voltage                     | 2.7             | 3.6 | 2.7            | 3.6 | V    |
| V <sub>IH</sub>     | High-level input voltage           | 2               |     | 2              |     | V    |
| V <sub>IL</sub>     | Low-level input voltage            |                 | 0.8 |                | 0.8 | V    |
| V <sub>I</sub>      | Input voltage                      |                 | 5.5 |                | 5.5 | V    |
| I <sub>OH</sub>     | High-level output current          |                 | -25 |                | -32 | mA   |
| I <sub>OL</sub>     | Low-level output current           |                 | 48  |                | 64  | mA   |
| Δt/Δv               | Input transition rise or fall rate | Outputs enabled |     | 10             | 10  | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                 | 200             |     | 200            |     | μs/V |
| T <sub>A</sub>      | Operating free-air temperature     | -55             | 125 | -40            | 125 | °C   |

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

### ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                       | TEST CONDITIONS  |  | SN54LVTH16244A        |     |     | –40°C to 85°C<br>SN74LVTH16244A |     |     | Recommended<br>–40°C to 125°C<br>SN74LVTH16244A |     |     | UNIT |
|---------------------------------|--|--|-----------------------|-----|-----|---------------------------------|-----|-----|---|-----|-----|------|
|                                 |  |  | MIN                   | TYP | MAX | MIN                             | TYP | MAX | MIN   | TYP | MAX |      |
| V <sub>IK</sub>                 | V <sub>CC</sub> = 2.7 V, I <sub>I</sub> = –18 mA   |  | –1.2                  |     |     | –1.2                            |     |     | –1.2  |     |     | V    |
| V <sub>OH</sub>                 | V <sub>CC</sub> = 2.7 V to 3.6 V, I <sub>OL</sub> = –100 μA  |  | V <sub>CC</sub> – 0.2 |     |     | V <sub>CC</sub> – 0.2           |     |     | V <sub>CC</sub> – 0.2                           |     |     | V    |
|                                 | V <sub>CC</sub> = 2.7 V, I <sub>OH</sub> = –8 mA   |  | 2.4                   |     |     | 2.4                             |     |     | 2.4   |     |     |      |
|                                 | V <sub>CC</sub> = 3 V  |  | 2                     |     |     | 2                               |     |     | 2   |     |     |      |
| V <sub>OL</sub>                 | V <sub>CC</sub> = 2.7 V  |  | 0.2                   |     |     | 0.2                             |     |     | 0.2   |     |     | V    |
|                                 |  |  | 0.5                   |     |     | 0.5                             |     |     | 0.5   |     |     |      |
|                                 | V <sub>CC</sub> = 3 V  |  | 0.4                   |     |     | 0.4                             |     |     | 0.4   |     |     |      |
|                                 |  |  | 0.5                   |     |     | 0.5                             |     |     | 0.5   |     |     |      |
|                                 |  |  | 0.55                  |     |     | 0.55                            |     |     | 0.55  |     |     |      |
|                                 |  |  | 0.55                  |     |     | 0.55                            |     |     | 0.55  |     |     |      |
| I <sub>I</sub>                  | V <sub>CC</sub> = 0 or 3.6 V, V <sub>I</sub> = 5.5 V   |  | 50                    |     |     | 10                              |     |     | 10  |     |     | μA   |
|                                 | Control inputs   | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND     | ±1                    |     |     | ±1                              |     |     | ±1  |     |     |      |
|                                 | Data inputs  | V <sub>CC</sub> = 3.6 V  | 1                     |     |     | 1                               |     |     | 1   |     |     |      |
| I <sub>off</sub>                | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V   |  |                       |     |     | ±100                            |     |     | ±100  |     |     | μA   |
| I <sub>I(hold)</sub>            | Data inputs  | V <sub>CC</sub> = 3 V, V <sub>I</sub> = 0.8 V                        | 75                    |     |     | 75                              |     |     | 75  |     |     | μA   |
|                                 |  | V <sub>CC</sub> = 3 V, V <sub>I</sub> = 2 V                          | –75                   |     |     | –75                             |     |     | –75   |     |     |      |
|                                 |  | V <sub>CC</sub> = 3.6 V <sup>(2)</sup> , V <sub>I</sub> = 0 to 3.6 V |                       |     |     | 500<br>–750                     |     |     | 500<br>–750                                     |     |     |      |
| I <sub>OZH</sub>                | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 3 V  |  | 5                     |     |     | 5                               |     |     | 5   |     |     | μA   |
| I <sub>OZL</sub>                | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0.5 V  |  | –5                    |     |     | –5                              |     |     | –5  |     |     | μA   |
| I <sub>OZPU</sub>               | V <sub>CC</sub> = 0 to 1.5 V, V <sub>O</sub> = 0.5 V to 3 V, $\overline{OE}$ = don't care                    |  | ±100 <sup>(3)</sup>   |     |     | ±100                            |     |     | ±100  |     |     | μA   |
| I <sub>OZPD</sub>               | V <sub>CC</sub> = 1.5 V to 0, V <sub>O</sub> = 0.5 V to 3 V, $\overline{OE}$ = don't care                    |  | ±100 <sup>(3)</sup>   |     |     | ±100                            |     |     | ±100  |     |     | μA   |
| I <sub>CC</sub>                 | V <sub>CC</sub> = 3.6 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND                         |  | 0.19                  |     |     | 0.19                            |     |     | 0.19  |     |     | mA   |
|                                 | Outputs high   |  | 5                     |     |     | 5                               |     |     | 5   |     |     |      |
|                                 | Outputs disabled   |  | 0.19                  |     |     | 0.19                            |     |     | 0.19  |     |     |      |
| ΔI <sub>CC</sub> <sup>(4)</sup> | V <sub>CC</sub> = 3 V to 3.6 V, One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND |  | 0.2                   |     |     | 0.2                             |     |     | 0.2   |     |     | mA   |
| C <sub>i</sub>                  | V <sub>I</sub> = 3 V or 0 V  |  | 4                     |     |     | 4                               |     |     | 4   |     |     | pF   |
| C <sub>o</sub>                  | V <sub>O</sub> = 3 V or 0 V  |  | 9                     |     |     | 9                               |     |     | 9   |     |     | pF   |

- (1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.
- (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.
- (3) On products compliant to MIL-PRF-38535, this parameter does not apply.
- (4) This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

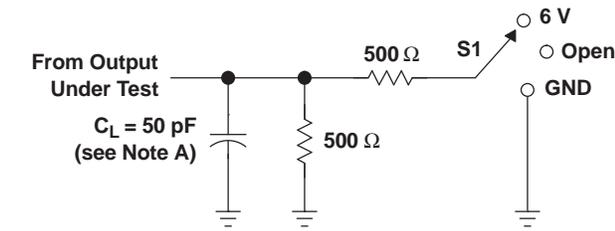
## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see [Figure 1](#))<sup>(1)</sup>

| PARAMETER    | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN54LVTH16244A                           |     |                         |     | –40°C to 85°C<br>SN74LVTH16244A          |     |                         |     | Recommended<br>–40°C to 125°C<br>SN74LVTH16244A |     |                         |     | UNIT |     |     |
|--------------|-----------------|----------------|--|-----|-------------------------|-----|--|-----|-------------------------|-----|---|-----|-------------------------|-----|------|-----|-----|
|              |                 |                | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$        |     | $V_{CC} = 2.7\text{ V}$ |     |      |     |     |
|              |                 |                | MIN                                      | MAX | MIN                     | MAX | MIN                                      | TYP | MAX                     | MIN | MAX   | MIN | TYP                     | MAX |      | MIN | MAX |
| $t_{PLH}$    | A               | Y              | 1.1                                      | 4.4 | 4.6                     |     | 1.2                                      | 2.3 | 3.2                     | 3.7 |   | 1.2 | 2.3                     | 4.4 | 4.6  |     | ns  |
| $t_{PHL}$    |                 |                | 1.1                                      | 3.6 | 3.9                     |     | 1.2                                      | 2   | 3.2                     | 3.7 |   | 1.2 | 2                       | 3.6 | 3.9  |     |     |
| $t_{PZH}$    | $\overline{OE}$ | Y              | 1.1                                      | 4.6 | 5.4                     |     | 1.2                                      | 2.6 | 4                       | 5   |   | 1.2 | 2.6                     | 4.6 | 5.4  |     | ns  |
| $t_{PZL}$    |                 |                | 1.1                                      | 5.4 | 6.2                     |     | 1.2                                      | 2.7 | 4                       | 5   |   | 1.2 | 2.7                     | 5.4 | 6.2  |     |     |
| $t_{PHZ}$    | $\overline{OE}$ | Y              | 1.6                                      | 5.7 | 6.2                     |     | 2.2                                      | 3.3 | 4.5                     | 5   |   | 2.2 | 3.3                     | 5.7 | 6.2  |     | ns  |
| $t_{PLZ}$    |                 |                | 1.2                                      | 5   | 4.7                     |     | 2  | 3.1 | 4.2                     | 4.4 |   | 2   | 3.1                     | 5   | 4.7  |     |     |
| $t_{sk(LH)}$ |                 |                |  |     |                         |     |  |     | 0.5                     |     |   | 0.5 |                         |     |      | ns  |     |
| $t_{sk(HL)}$ |                 |                |  |     |                         |     |  |     | 0.5                     |     |   | 0.5 |                         |     |      |     |     |

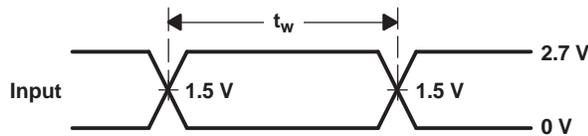
(1) All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

PARAMETER MEASUREMENT INFORMATION

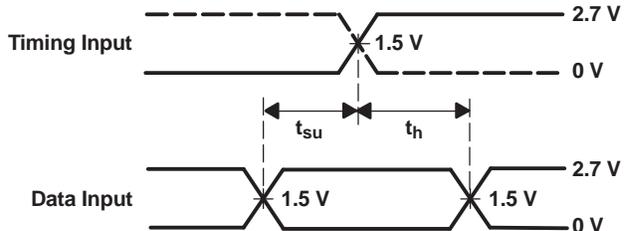


LOAD CIRCUIT

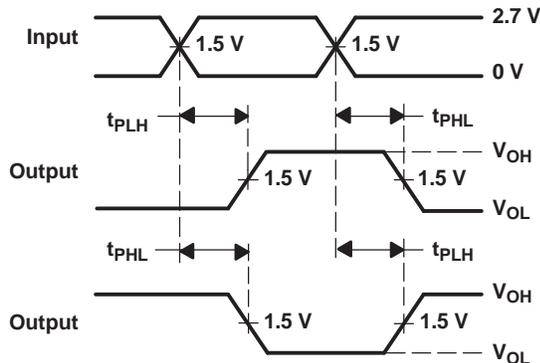
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



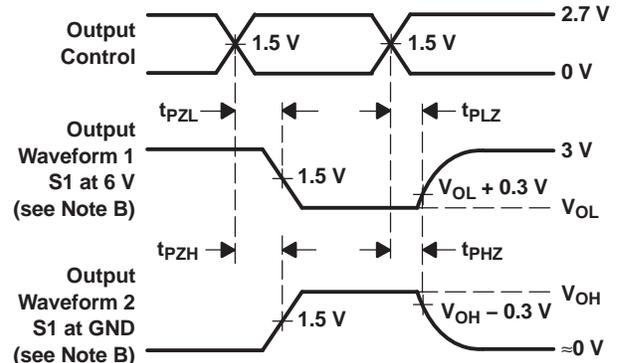
VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.  
 D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**REVISION HISTORY**

| <b>Changes from Revision T (November 2006) to Revision U</b>                    | <b>Page</b> |
|---|-------------|
| • Updated document to new TI data sheet format - no specification changes. .... | <b>1</b>    |
| • Removed ordering information. ....  | <b>1</b>    |
| • Updated operating temperature range. ....                                     | <b>5</b>    |

PACKAGING INFORMATION

| Orderable Device   | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)  | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                      | Samples |
|--------------------|---------------|--------------|-----------------|------|-------------|------------------|--------------------------------------|----------------------|--------------|--|---------|
| 5962-9668501QXA    | ACTIVE        | CFP          | WD              | 48   | 1           | Non-RoHS & Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9668501QX<br>A<br>SNJ54LVTH16244<br>AWD | Samples |
| 5962-9668501VXA    | ACTIVE        | CFP          | WD              | 48   | 1           | Non-RoHS & Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9668501VX<br>A<br>SNV54LVTH16244<br>AWD | Samples |
| 74LVTH16244ADGGRE4 | ACTIVE        | TSSOP        | DGG             | 48   | 2000        | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| 74LVTH16244ADGGRG4 | ACTIVE        | TSSOP        | DGG             | 48   | 2000        | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| SN74LVTH16244ADGGR | ACTIVE        | TSSOP        | DGG             | 48   | 2000        | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| SN74LVTH16244ADGVR | ACTIVE        | TVSOP        | DGV             | 48   | 2000        | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LL244A                                       | Samples |
| SN74LVTH16244ADL   | ACTIVE        | SSOP         | DL              | 48   | 25          | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| SN74LVTH16244ADLG4 | ACTIVE        | SSOP         | DL              | 48   | 25          | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| SN74LVTH16244ADLR  | ACTIVE        | SSOP         | DL              | 48   | 1000        | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | LVTH16244A                                   | Samples |
| SNJ54LVTH16244AWD  | ACTIVE        | CFP          | WD              | 48   | 1           | Non-RoHS & Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9668501QX<br>A<br>SNJ54LVTH16244<br>AWD | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LVTH16244A, SN54LVTH16244A-SP, SN74LVTH16244A :**

● Catalog : [SN74LVTH16244A](#), [SN54LVTH16244A](#)

● Enhanced Product : [SN74LVTH16244A-EP](#), [SN74LVTH16244A-EP](#)

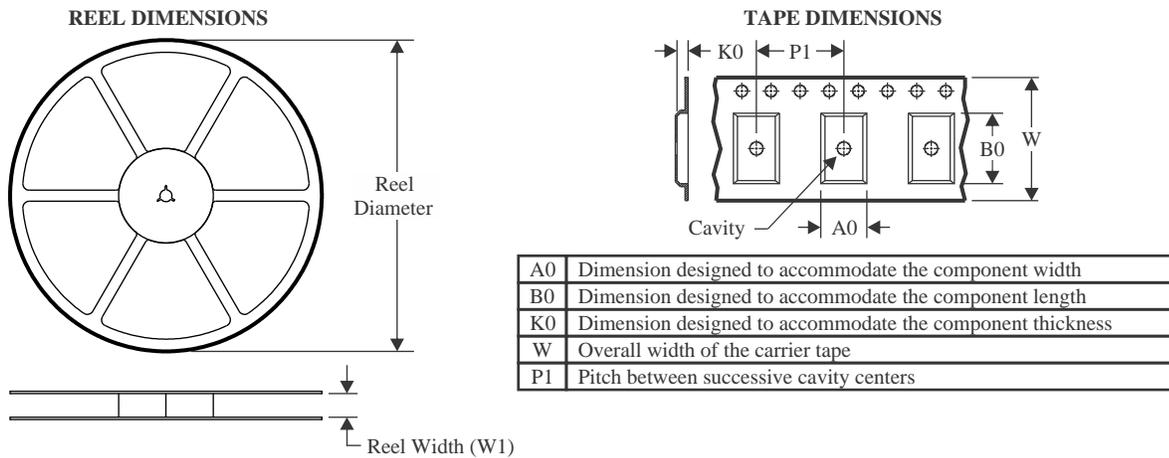
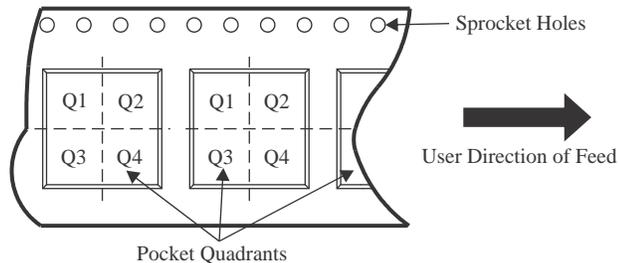
● Military : [SN54LVTH16244A](#)

● Space : [SN54LVTH16244A-SP](#)

NOTE: Qualified Version Definitions:

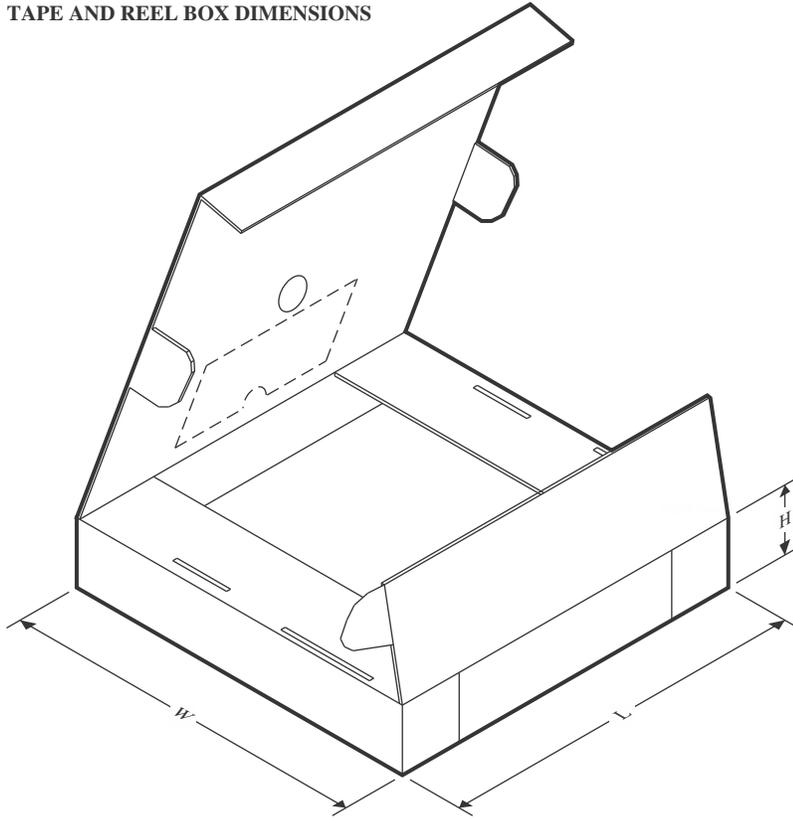
- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


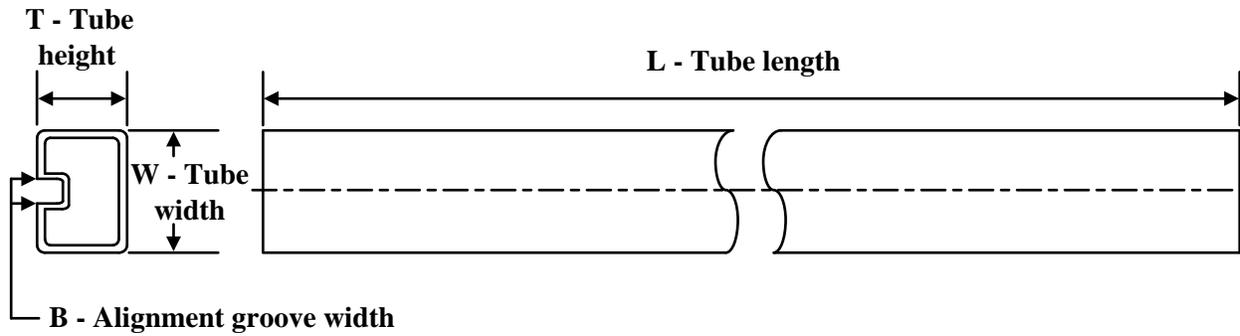
\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVTH16244ADGGR | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74LVTH16244ADGVR | TVSOP        | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |
| SN74LVTH16244ADLR  | SSOP         | DL              | 48   | 1000 | 330.0              | 32.4               | 11.35   | 16.2    | 3.1     | 16.0    | 32.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVTH16244ADGGR | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LVTH16244ADGVR | TVSOP        | DGV             | 48   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LVTH16244ADLR  | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

**TUBE**


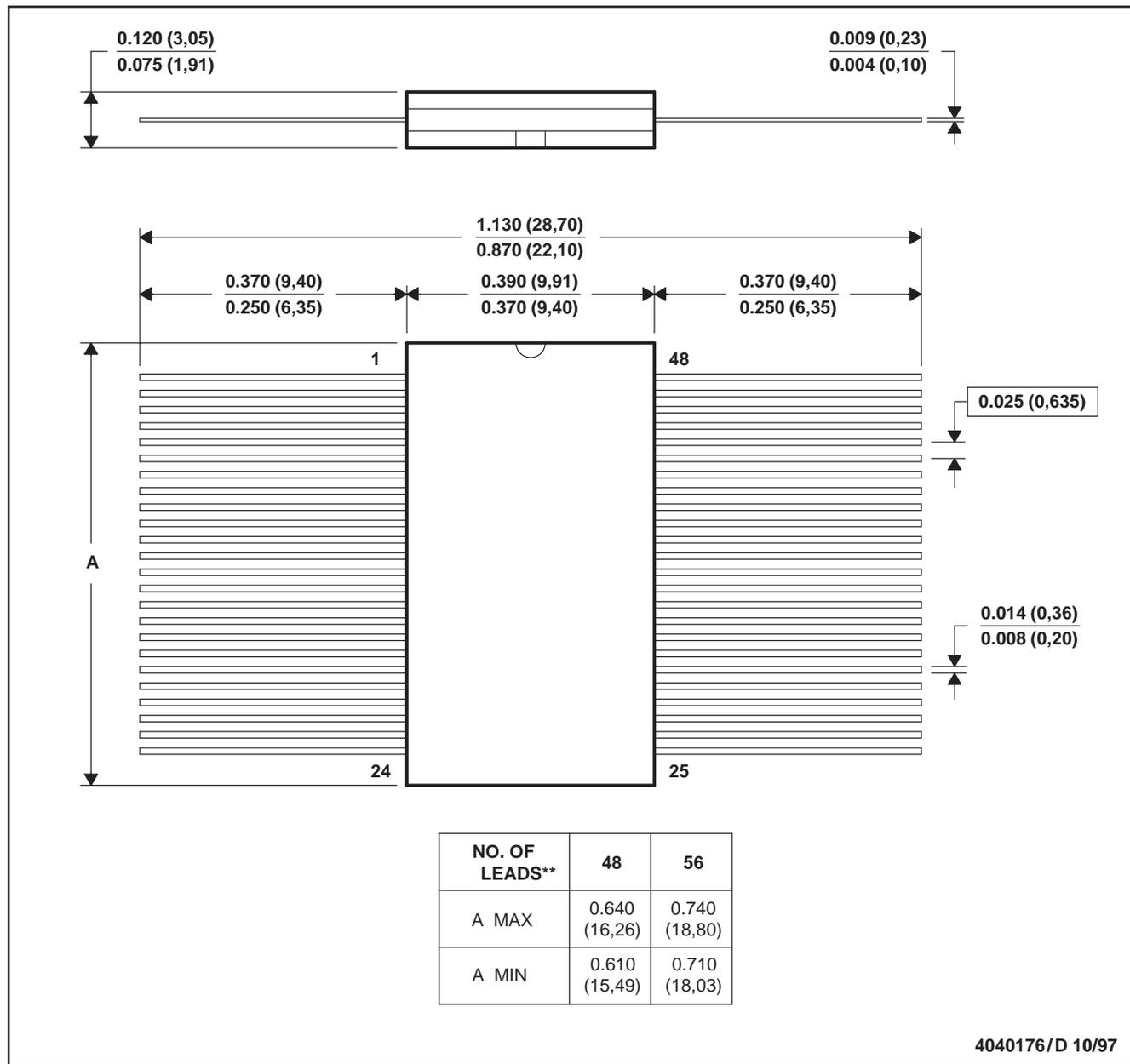
\*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVTH16244ADL   | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74LVTH16244ADLG4 | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |

WD (R-GDFP-F\*\*)

CERAMIC DUAL FLATPACK

48 LEADS SHOWN

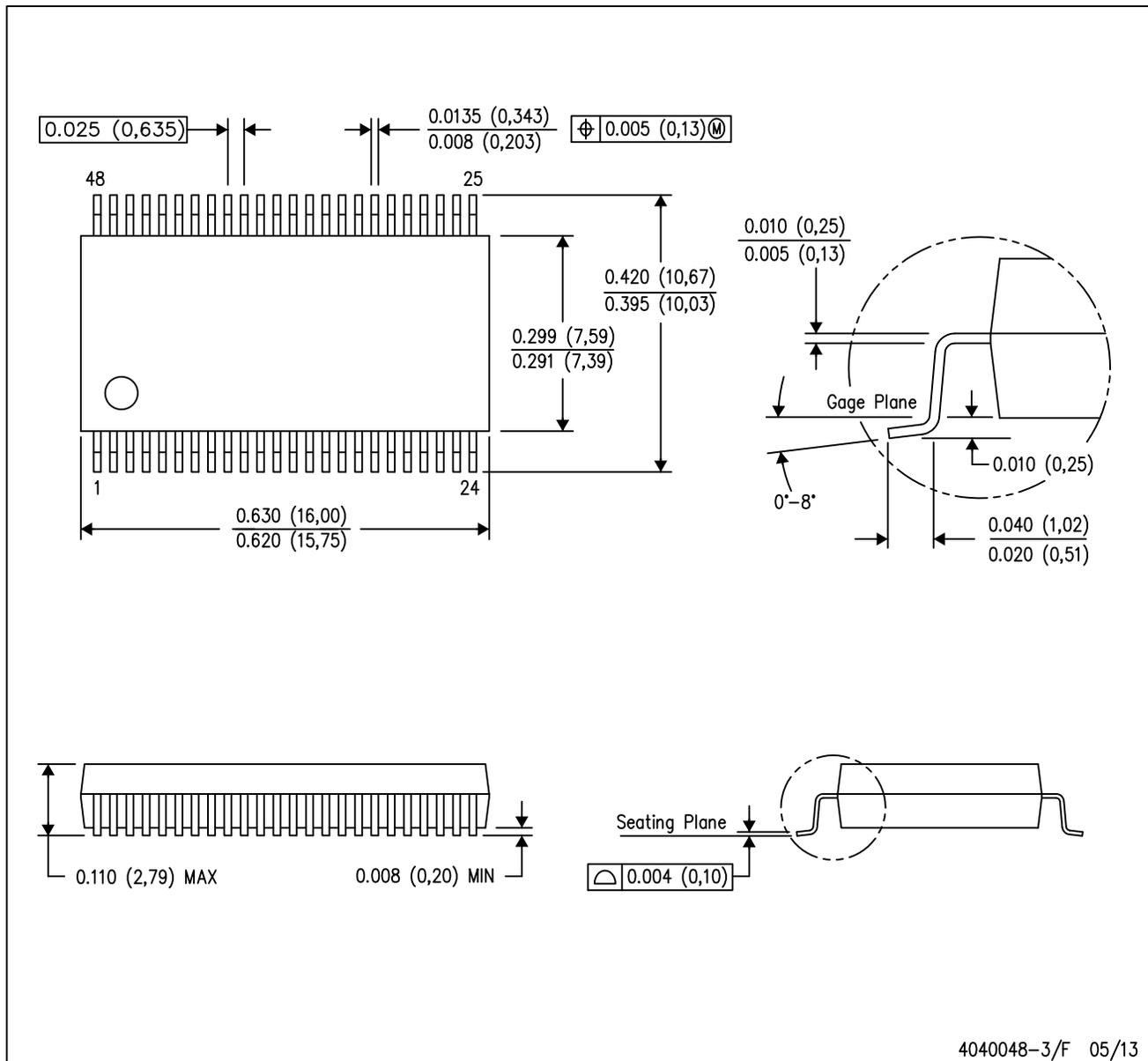


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only  
 E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA  
 GDFP1-F56 and JEDEC MO-146AB

# MECHANICAL DATA

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



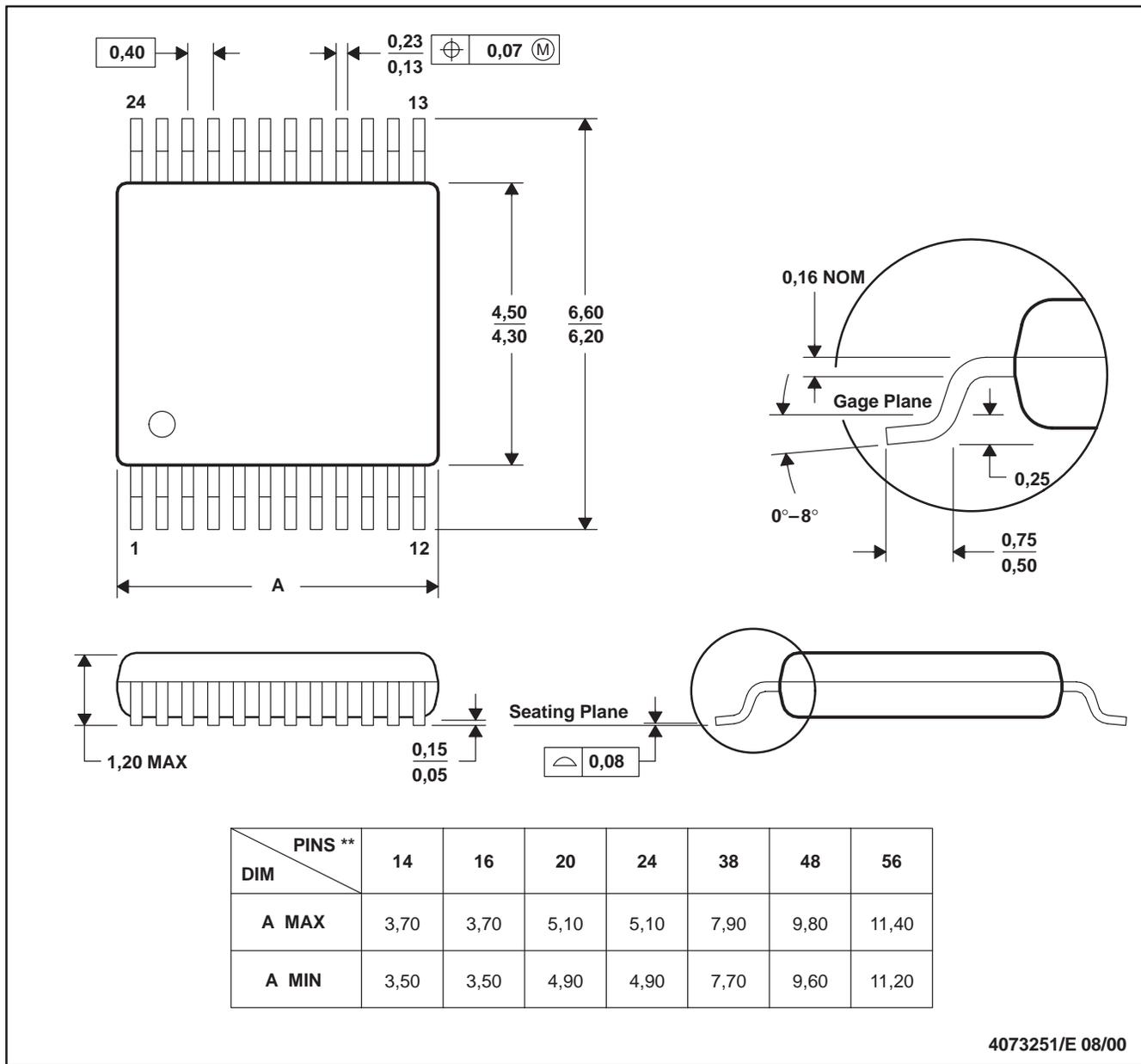
- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.

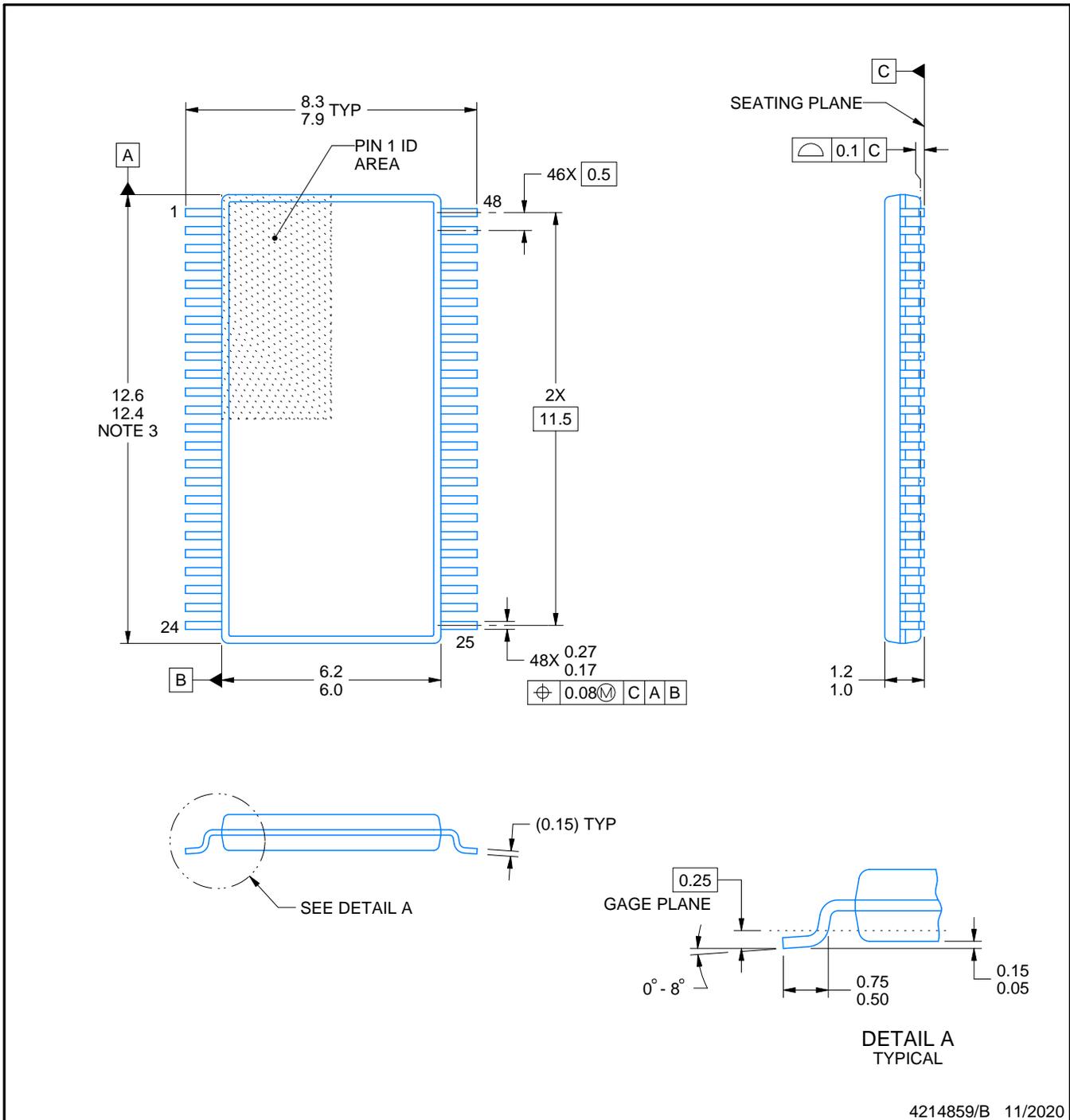
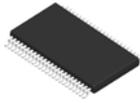
DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194



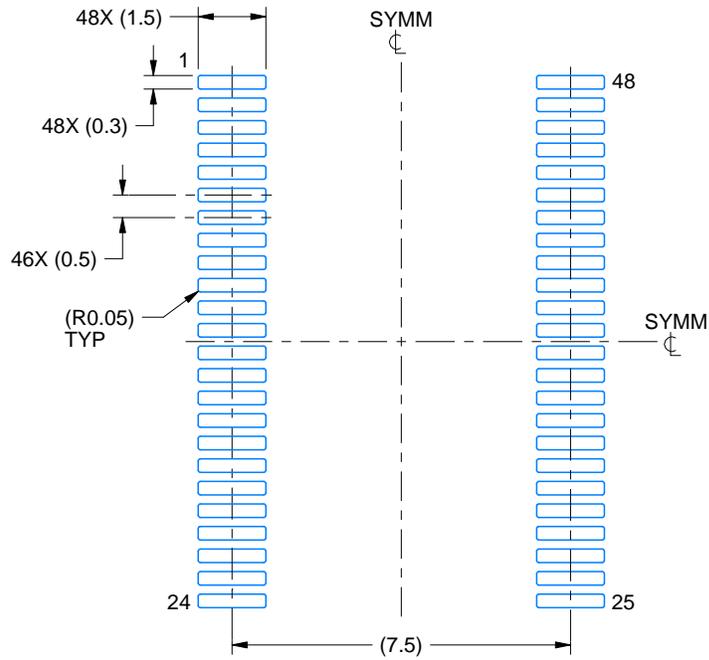
4214859/B 11/2020

# EXAMPLE BOARD LAYOUT

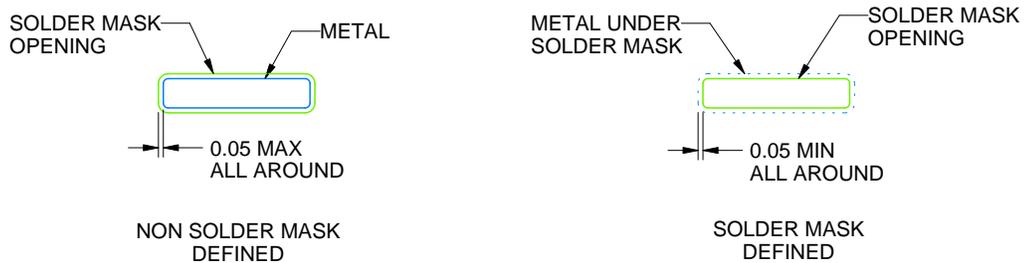
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4214859/B 11/2020

NOTES: (continued)

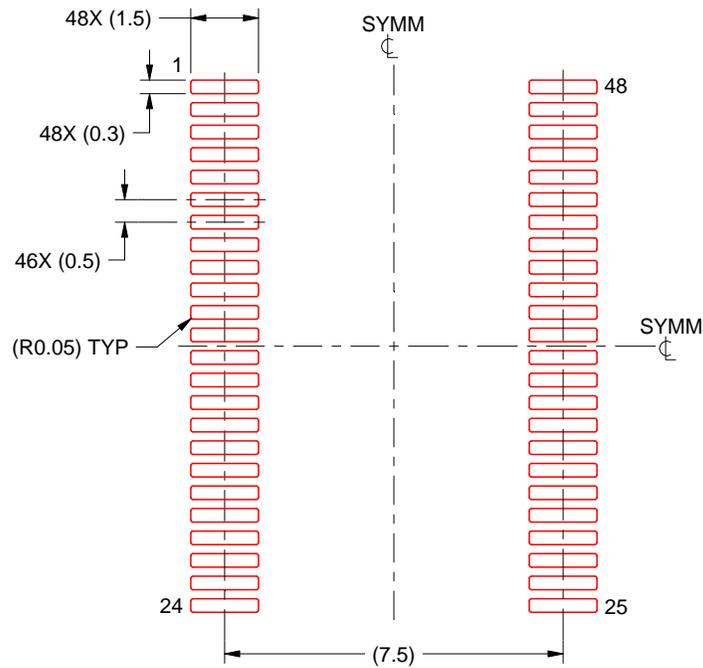
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4214859/B 11/2020

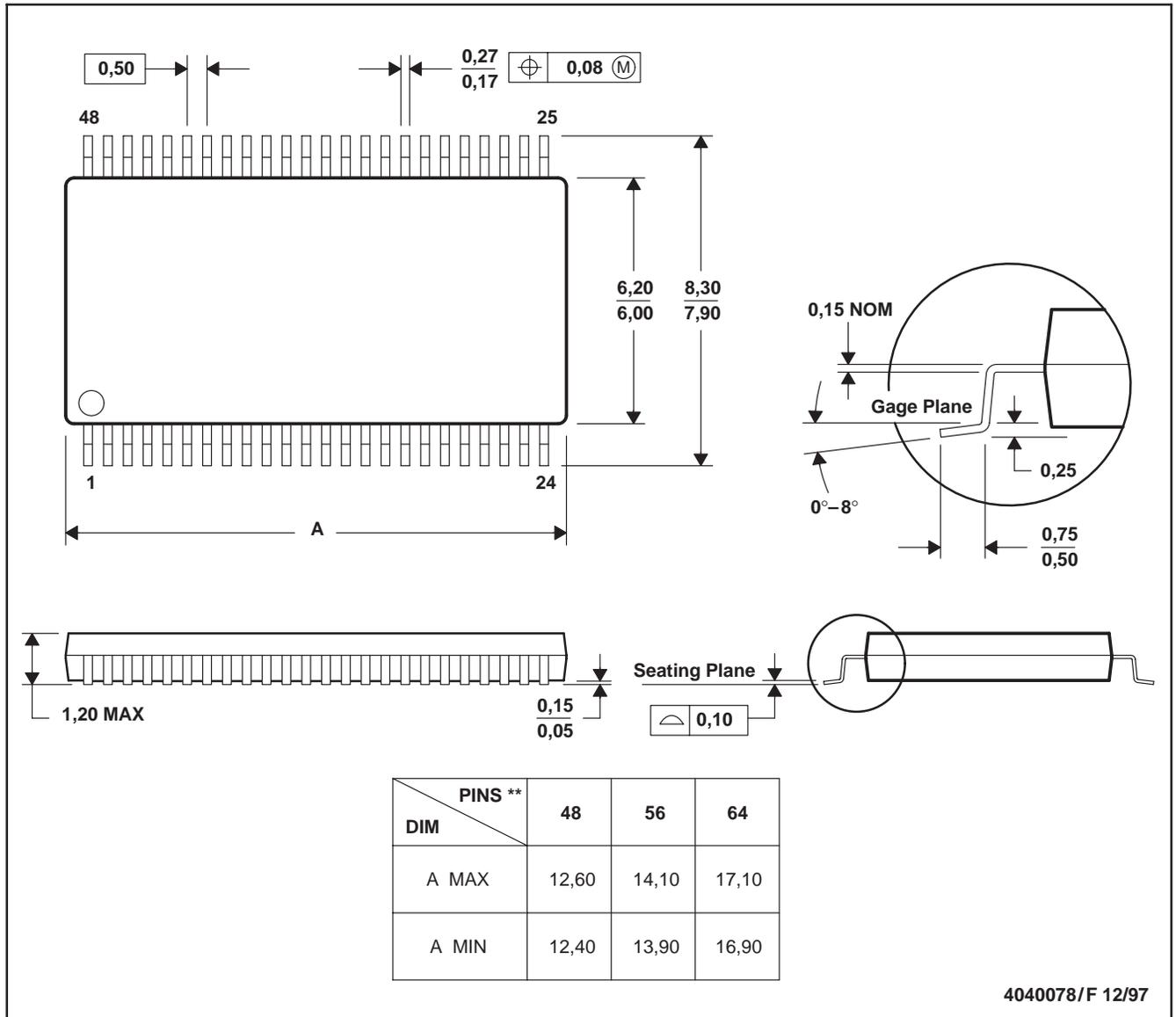
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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